

# Datasheet PCB Slide Switch DPDT On-On Slide

RS Stock number 429-509



# SPECIFICATIONS

CONTACT RATING: Dependent upon contact material MECHANICAL LIFE: 30,000 make-and-break cycles. CONTACT RESISTANCE: 20m  $\Omega$  max. initial @ 2-4VDC 100mA for both silver and gold plated contacts. INSULATION RESISTANCE: 1,000M  $\Omega$  min. DIELETRIC STRENGTH: 1,000 V RMS@sea level. OPERATING TEMPERATURE: -30°C to 85°C.

# MATERIALS

CASE - Diallyl phthalate (DAP)(UL94V-0)
HOUSING - Brass,tin plated
ACTUATOR - Nylon, black.
CONTACT - Silver or gold plated.
TERMINALS - Copper alloy, with silver and gold plated.



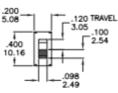
### SWITCH FUNCTION

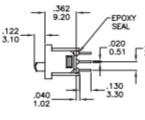
	UL/CSA		SWITCH FUNCTION			CONNECTED TERMINALS / SCHEMATIC		
NO. POLES	MODEL	MODEL	POS.1	POS.2	POS.3	POS.1	POS.2	POS.3
FOLES	NO.	NO.				-	-	_
SP	Q2511	5FS1	ON	NONE	ON	2-1 / 20046	OPEN	2-3 \800#0
	Q2512	5FS2	ON	NONE	MOM			
	Q2513	5FS3	ON	OFF	ON	1/ -3		1. 13
DP	Q2521	5FD1	ON	NONE	ON	2-1,5-4	OPEN	2-3,5-6
	Q2523	5FD3	ON	OFF	ON	1 + 20000 + 5 1 + -3 + -6		1. 73 4. 76

MOM=MOMENTARY

### POLE OPTIONS

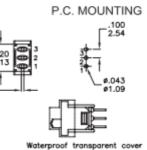






100

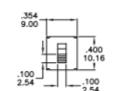
.030

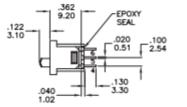


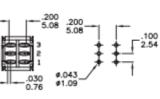
SPDT

Part No. Shown : 5FS1S102M2QE









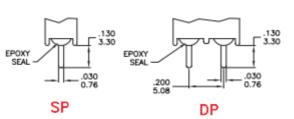
P.C. MOUNTING

DPDT

Part No. Shown : 5FD1S102M2QE

### TERMINATION OPTIONS

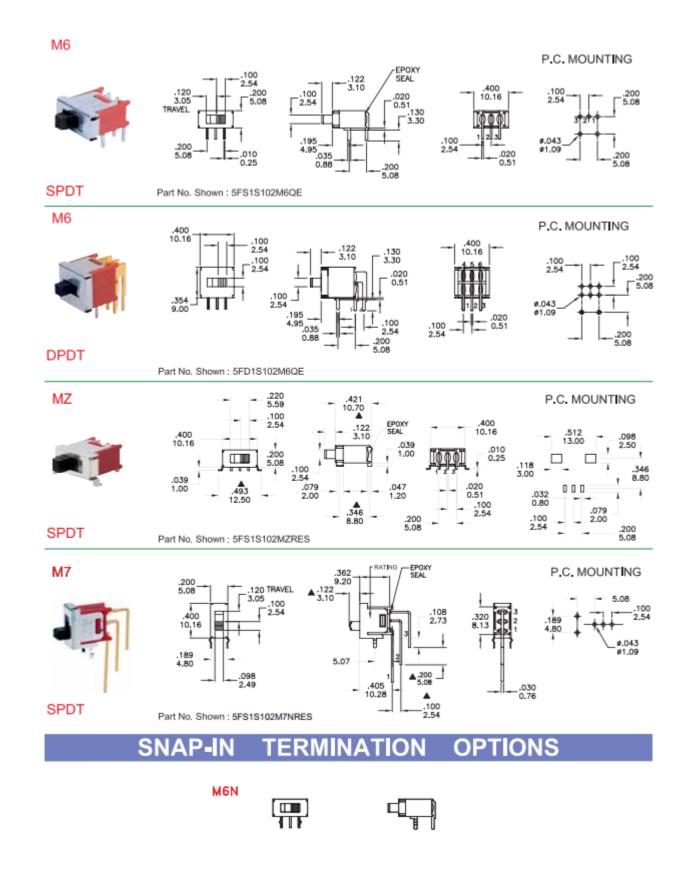
M2 PC THRU-HOLE



OTHER TERMINATION OPTIONS

M6 RIGHT ANGLE P.C. MOUNT M6N SNAP - IN RIGHT ANGLE P.C. MOUNT







### CONTACT MATERIAL OPTIONS

Q=Silver R=Gold	<u>Q.C.S.K</u>	<u>R.G</u>
G=Gold,tin-lead S=Silver,tin-lead	FIXED TERMINAL: Silver plated over copper alloy	FIXED TERMINAL: Copper alloy with gold plated over nickel plated
C=Gold over silver K=Gold over silver	MOVABLE CONTACT: Silver plated over copper alloy	MOVABLE CONTACT: Copper alloy with gold plated over nickel plated
,tin-lead	RATING: 3 Amps with resistant load @ 120VAC or 28VDC 1 Amps with resistant load @ 250VAC	RATING:0.4 Volt-Amps(VA)max. @ 20V max. (AC or DC)







#### SOLDERING PROCESSES

MANUAL SOLDERING : Use soldering iron of 30 watts, controlled at 350°C approximately 5 seconds while applying solder. WAVE SOLDERING : Recommended Soldering Temperature:260±5°C Duration of Solder Immersion: 5 ±1 seconds (PCB is 1.6mm in thickness)

SOLDERING : Vapor phase

